## IN THE CLAIMS

Please amend the claims as follows:

Claim 1 (Currently Amended): An aqueous dispersion having a pH value of between 3 and 7 containing comprising 1 to 35 wt.% of a pyrogenically produced silicon-aluminium mixed oxide powder with a specific surface area of 5 to 400 m<sup>2</sup>/g, characterised in that wherein

- the proportion of aluminium oxide in the powder is between 90 and 99.9 wt.% or between 0.01 and 10 wt.%[[,]];
- the surface of the powder comprises zones of aluminium oxide and silicon dioxide[[,]]; and
- the powder exhibits no signals for crystalline silicon dioxide in an X-ray diffractogram.

Claim 2 (Currently Amended): An The aqueous dispersion according to claim 1, eharacterised in that wherein the dispersion comprises 0.3-20 wt.% of an oxidising oxidizing agent.

Claim 3 (Currently Amended): An The aqueous dispersion according to claim 1 or 2, eharacterised in that it contains wherein the dispersion comprises additives.

Claim 4 (Currently Amended): An The aqueous dispersion according to elaims 1 to 3 claim 1, eharacterised in that wherein, in addition to the silicon-aluminium mixed oxide powder, it contains the dispersion comprises at least a further metal oxide powder selected from the group comprising consisting of silicon dioxide, aluminium oxide, cerium oxide, zirconium oxide and titanium dioxide.

Claim 5 (Currently Amended): Use of the aqueous dispersion according to claims 1 to 4 for the A method of chemical-mechanical polishing of conductive, metallic films comprising polishing conductive, metallic films with the aqueous dispersion according to claim 1.

Claim 6 (Currently Amended): Use of the aqueous dispersion according to claims 1 to 4 for the A method of chemical-mechanical polishing of conductive, metallic films which comprising polishing conductive, metallic films with the aqueous dispersion according to claim 1, wherein the conductive, metallic films are applied on an insulating barrier layer.